



OKI Semiconductor

FEDR27T12800J-02-07 Issue Date: Jul. 9, 2004

MR27T12800J

 $8M-Word \times 16$ -Bit or $16M-Word \times 8$ -Bit P2ROM

FEATURES

 $\cdot 8,388,608$ -word \times 16-bit/16,777,216-word \times 8-bit electrically switchable configuration

- · Access time
 - · MR27T12800J-xxxTN, MR27T12800J-xxxTY
 - · 2.7 V to 3.6 V power supply 90 ns MAX
 - · MR27T12800J-xxxTNE, MR27T12800J-xxxTYE
 - · 2.7 V to 3.0 V power supply 120 ns MAX
 - \cdot 3.0 V to 3.6 V power supply 100 ns MAX
- · Operating current 25 mA MAX(5MHz)
- · Standby current 10 µA MAX
- · Input/Output TTL compatible
- · Three-state output

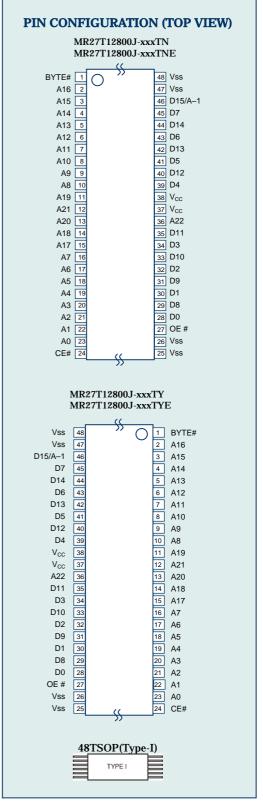
PACKAGES

- $\cdot MR27T12800J\text{-}xxxTN \text{ , } MR27T12800J\text{-}xxxTNE \\ 48\text{-pin plastic TSOP (TSOP I 48-P-1220-0.50-1K)}$
- · MR27T12800J-xxxTY, MR27T12800J-xxxTYE 48-pin plastic TSOP (TSOP I 48-P-1220-0.50-L)

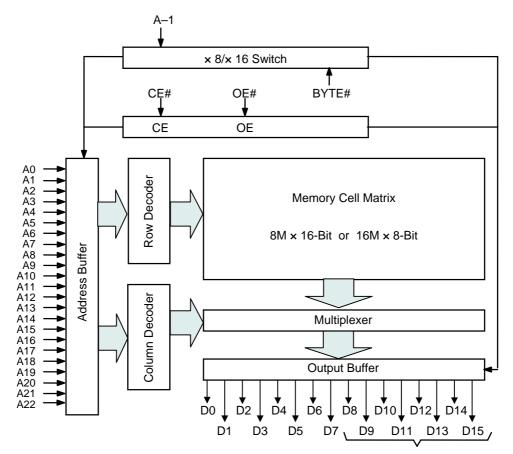
P2ROM ADVANCED TECHNOLOGY

P2ROM stands for Production Programmed ROM. This exclusive Oki technology utilizes factory test equipment for programming the customers code into the P2ROM prior to final production testing. Advancements in this technology allows production costs to be equivalent to MASKROM and has many advantages and added benefits over the other non-volatile technologies, which include the following;

- Short lead time, since the P2ROM is programmed at the final stage of the production process, a large P2ROM inventory "bank system" of un-programmed packaged products are maintained to provide an aggressive lead-time and minimize liability as a custom product.
- No mask charge, since P2ROMs do not utilize a custom mask for storing customer code, no mask charges apply.
- No additional programming charge, unlike Flash and OTP that require additional programming and handling costs, the P2ROM already has the code loaded at the factory with minimal effect on the production throughput. The cost is included in the unit price.
- Custom Marking is available at no additional charge.
- · Pin Compatible with Mask ROM



BLOCK DIAGRAM



In 8-bit output mode, these pins are placed in a high-Z state and pin D15 functions as the A-1 address pin.

PIN DESCRIPTIONS

Pin name	Functions			
D15 / A-1	Data output / Address input			
A0 to A22	Address inputs			
D0 to D14	Data outputs			
CE#	Chip enable input			
OE#	Output enable input			
BYTE#	Word / Byte select input			
V _{CC}	Power supply voltage			
V _{SS}	Ground			

FUNCTION TABLE

Mode	CE#	OE#	BYTE#	V _{CC}	D0 to D7	D8 to D14	D15/A-1
Read (16-Bit)	L	L	Н			D _{OUT}	
Read (8-Bit)	L	L	L	0.7./	D _{OUT}	Hi–Z	L/H
Output disable			Н	2.7 V		11: 7	
Output disable	L	Н	L	L to 3.6 V		Hi–Z	*
Otan dlavi	- 11		Н	3.0 V			
Standby	Н	*	L			Hi–Z	*

^{*:} Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Та		0 to 70	°C
Storage temperature	Tstg	_	-55 to 125	°C
Input voltage	VI		-0.5 to V _{CC} +0.5	V
Output voltage	Vo	relative to V _{SS}	-0.5 to V _{CC} +0.5	V
Power supply voltage	Vcc		–0.5 to 5	V
Power dissipation per package	P _D	Ta = 25°C	1.0	W
Output short circuit current	los	_	10	mA

RECOMMENDED OPERATING CONDITIONS

 $(Ta = 0 \text{ to } 70^{\circ}C)$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V _{CC} power supply voltage	Vcc		2.7	_	3.6	V
Input "H" level	V _{IH}	$V_{CC} = 2.7 \text{ to } 3.6 \text{ V}$	2.2	_	V _{CC} +0.5*	V
Input "L" level	V_{IL}		-0.5**	_	0.6	V

Voltage is relative to V_{SS}.

* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

PIN CAPACITANCE

 $(V_{CC} = 3.0 \text{ V}, \text{Ta} = 25^{\circ}\text{C}, \text{f} = 1 \text{ MHz})$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	C _{IN1}	V _I = 0 V	_	_	8	
BYTE#	C _{IN2}	V ₁ = 0 V	_	_	200	pF
Output	C _{OUT}	$V_O = 0 V$	_	_	10	

^{**: -1.5}V(Min.) when pulse width of undershoot is less than 10ns.

ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

 $(V_{CC} = 2.7 \text{ to } 3.6 \text{ V}, \text{ Ta} = 0 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input leakage current	ILI	$V_I = 0$ to V_{CC}	_	_	5	μΑ
Output leakage current	I _{LO}	$V_O = 0$ to V_{CC}	_	_	5	μА
V _{CC} power supply current	Iccsc	CE# = V _{CC}	_	_	10	μА
(Standby)	I _{CCST}	CE# = V _{IH}	_	_	1	mA
V _{CC} power supply current		CE# = V _{IL} , OE# = V _{IH}			25	Λ
(Read)	Icca	f=5MHz			25	mA
Input "H" level	V _{IH}	_	2.2	_	V _{CC} +0.5*	V
Input "L" level	V _{IL}	_	-0.5**	_	0.6	V
Output "H" level	V _{OH}	$I_{OH} = -1 \text{ mA}$	2.4	_	_	V
Output "L" level	V _{OL}	$I_{OL} = 2 \text{ mA}$	_	_	0.4	V

Voltage is relative to V_{SS}.

- * : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.
- **: -1.5V(Min.) when pulse width of undershoot is less than 10ns.

AC CHARACTERISTICS

- MR27T12800J-xxxTN, MR27T12800J-xxxTY

1	$V_{CC} =$	27	to	3.6	V	Ta =	O to	70°	<u>(,)</u>
١	$v_{CC} =$	2.1	ιU	3.0	ν,	1 a =	UIL	, , , ,	U)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t _C	_	90		ns
Address access time	t _{ACC}	CE# = OE# = V _{IL}		90	ns
CE# access time	t _{CE}	OE# = V _{IL}	_	90	ns
OE# access time	t _{OE}	CE# = V _{IL}		30	ns
Output disable time	t _{CHZ}	OE# = V _{IL}	0	20	ns
Output disable time	t _{OHZ}	CE# = V _{IL}	0	20	ns
Output hold time	t _{OH}	CE# = OE# = V _{IL}	0	_	ns

- MR27T12800J-xxxTNE, MR27T12800J-xxxTYE

$(V_{CC} = 2.7)$	to 3.6 V	, Ta = 0	to 70°C)
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Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	+ -		120(V _{CC} = 2.7 to 3.0 V)		ne
Address cycle lifte	t _C		$100(V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$		ns
Address access time	.	120(\)		$120(V_{CC} = 2.7 \text{ to } 3.0 \text{ V})$	ne
Address access time	t _{ACC}	CE# = OE# = V _{IL}	_	$100(V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$	ns
CE# access time		0E# = V _{II}		$120(V_{CC} = 2.7 \text{ to } 3.0 \text{ V})$	no
CE# access time	t _{CE}	OE# = VIL	_	$100(V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$	ns
OE# access time	t _{OE}	$CE# = V_{IL}$	_	30	ns
Output diaable time	t _{CHZ}	OE# = V _{IL}	0	20	ns
Output disable time	t _{OHZ}	CE# = V _{IL}	0	20	ns
Output hold time	t _{OH}	CE# = OE# = V _{IL}	0		ns

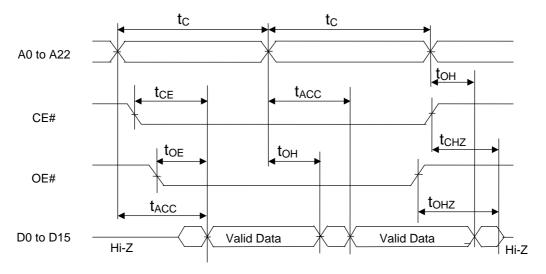
Measurement conditions

Output load

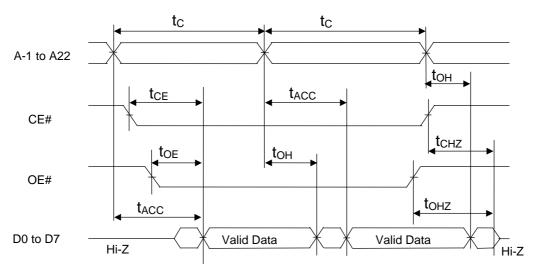


TIMING CHART (READ CYCLE)

16-Bit READ MODE (BYTE# = V_{IH})

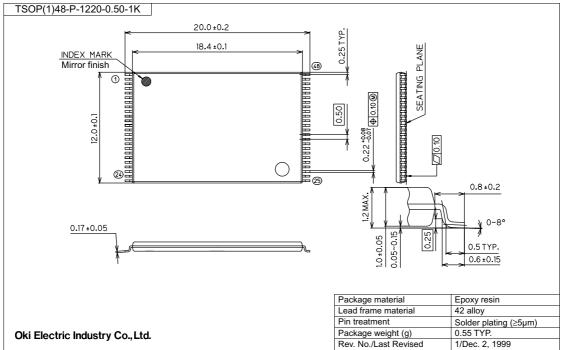


8-BIT READ MODE (BYTE# = V_{IL})



PACKAGE DIMENSIONS

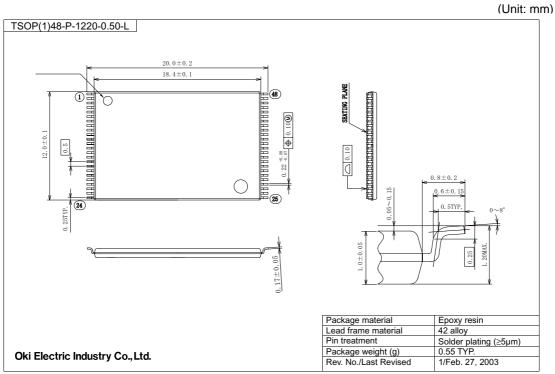




Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).



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REVISION HISTORY

Document		Page		
No.	Date Previous Current Edition Edition			Description
FEDR27T12800J-02-01	July. 2002	_	ı	
FEDR27T12800J-02-02	Jan. 2003	1, 5	1, 5	Change tC, tACC, tCE to 120ns
FEDR27T12800J-02-03	Jan. 2003	1	1	Added P/N to MR27T12800J-xxxTNE
FEDR27T12800J-02-04	Feb. 2003	1, 5	1, 5	Added MR27T12800J-xxxTY
FEDR27T12800J-02-05	Mar. 10, 2003	1, 5	1, 5	1.Change tC, tACC, tCE to 90ns(MR27T12800J-xxxTY) 2. Added MR27T12800J-xxxTYE
FEDR27T12800J-02-06	Jun. 4, 2003	3, 4, 5	3, 4, 5	Change Ta to 0°C
FEDR27T12800J-02-07	Jul. 9, 2004	3	3	Add P _D condition and I _{OS} = 10mA

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